

### AMENDMENTS TO THE CLAIMS

Claims 1-14 were pending prior to the entry of these amendments. Please cancel Claims 1-8 without prejudice or disclaimer. Please amend Claim 9 as indicated below.

1. (Canceled)
2. (Canceled)
3. (Canceled)
4. (Canceled)
5. (Canceled)
6. (Canceled)
7. (Canceled)
8. (Canceled)

9. (Currently Amended) An edge copper removal system for removing conductive material from an edge region of a workpiece subsequent to an electrochemical process as the workpiece rotated, wherein the edge region comprises a front edge surface, a back edge surface, and a bevel, the system comprising:

at least one nozzle for directing a first etchant flow onto the back edge surface of the workpiece; and

at least one other nozzle for directing a second etchant flow onto the front surface edge of the workpiece.

10. (Original) The system of Claim 9, wherein the at least one nozzle and the at least one other nozzle receive etchant from the same etchant supply tank.

11. (Original) The system of Claim 9, wherein the at least one nozzle and the at least one other nozzle receive etchant from different etchant supply tanks.

12. (Original) The system of Claim 9, wherein the at least one nozzle and the at least one other nozzle are integral parts of an edge copper removal device.

13. (Original) The system of Claim 9, wherein a flow rate of the first etchant flow is different than a flow rate of the second etchant flow.

14. (Original) The system of Claim 9, wherein a flow rate of the first etchant flow is the same as a flow rate of the second etchant flow.